

Final Product/Process Change Notification Document #:FPCN25132X Issue Date:17 May 2023

TO247 Assembly and Test Qualification of Shantou Huashan (SHEDCL), China for capacity expansion.		
22 Aug 2023 or earlier if approved by customer		
Jeanie.Wang@onsemi.com		
Contact your local onsemi Sales Office. Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.		
Contact your local onsemi Sales Office or Lalan.Ortega@onsemi.com		
This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. onsemi will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact PCN.Support@onsemi.com		
The traceability of marking will be maintained by assembly plant code, date code and lot code.		
Assembly Change, Test Change		
Manufacturing Site Addition		
	External Foundry/Subcon Sites	
	SHANTOU HUASHAN Electronic Devices Co., Ltd., China	
	22 Aug 2023 or earlie   Jeanie.Wang@onsem   Contact your local on   Sample requests are to   Initial PCN or Final PC   Samples delivery timi   packing/label require   Contact your local on   This is a Final Product   90 days prior to imple   onsemi will consider to   delivery of this notice   The traceability of mag   Assembly Change, Te	

This Product Change Notification is to announce qualification of TO247 assembly and test sites at Shantou Huashan (SHEDCL), China.

There are no changes in product electrical performances and specifications.

	Before Change Description	After Change Description		
Assembly Site	onsemi Suzhou (ONSZ)	onsemi Suzhou (ONSZ)	Shantou Huashan (SHEDCL)	
Test Site	onsemi Suzhou (ONSZ)	onsemi Suzhou (ONSZ)	Shantou Huashan (SHEDCL)	
Die Attach (For all devices of the list)	Use Pb base solder, DA SLDR WIRE PB92.5SN5AG2.5	Use Pb base solder, DA SLDR WIRE PB92.5SN5AG2.5	, , , , , , , , , , , , , , , , , , , ,	

The traceability of marking will be maintained by assembly plant code, data code and lot code.

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### **Reliability Data Summary:**

QV DEVICE NAME: NTH027N65S3F-F155 RMS: U88928, O89276, S89282

## PACKAGE: TO-247

Test	Specification	Condition	Interval	Results
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High Temperature Reverse Bias	JESD22-A108	Ta=150°C, 100% max rated V	1008 hrs	0/231
High Temperature Gate Bias	JESD22-A108	Ta=150°C, 100% max rated Vgss	1008 hrs	0/231
High Temperature Storage Life	JESD22-A103	Ta=150°C	1008 hrs	0/231
Intermittent Operating Life	MIL-STD- 750(M1037) AEC-Q101	Ta=+25°C, delta Tj=100°C On/off = 5.0 min	6000 сус	0 / 120
Temperature Cycling	JESD22-A104	Ta= -55°C to +150°C	1000 cyc	0/231
Highly Accelerated Stress Test	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
Unbiased Highly Accelerated Stress Test	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
Resistance to Solder Heat	JESD22- B106	Ta = 268°C, 10 sec Required for through hole devices only		0 / 90
Solderability	JSTD002	Ta = 245°C, 5 sec		0 / 45
Physical Dimensions	JESD22-B120			0 / 30

### **Electrical Characteristics Summary:**

Electrical characteristics are not impacted.

## List of Affected Parts:

**Note:** Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal.** 

Part Number	Qualification Vehicle	
NTHL190N65S3HF	NTH027N65S3F-F155	
NTHL110N65S3F	NTH027N65S3F-F155	
NTHL095N65S3HF	NTH027N65S3F-F155	
NTHL082N65S3HF	NTH027N65S3F-F155	
NTHL082N65S3F	NTH027N65S3F-F155	
NTHL065N65S3F	NTH027N65S3F-F155	
NTHL065N65S3HF	NTH027N65S3F-F155	
NTHL050N65S3HF	NTH027N65S3F-F155	
NTHL040N65S3HF	NTH027N65S3F-F155	
NTHL040N65S3F	NTH027N65S3F-F155	
NTHL033N65S3HF	NTH027N65S3F-F155	
NTH027N65S3F-F155	NTH027N65S3F-F155	
NTHL027N65S3HF	NTH027N65S3F-F155	